# BCX17LT1, BCX18LT1, PNP BCX19LT1, NPN

# **General Purpose Transistors**

(Voltage and Current are Negative for PNP Transistors)

#### **Features**

• Pb-Free Package is Available



Rating	Symbol	Value	Unit
Collector–Emitter Voltage BCX17LT1, BCX19LT1 BCX18LT1	V <sub>CEO</sub>	45 25	Vdc
Collector-Base Voltage BCX17LT1, BCX19LT1 BCX18LT1	V <sub>CBO</sub>	50 30	Vdc
Emitter – Base Voltage	V <sub>EBO</sub>	5.0	Vdc
Collector Current – Continuous	Ic	500	mAdc

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

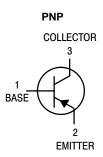
## THERMAL CHARACTERISTICS

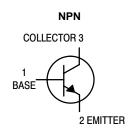
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1), T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225	mW mW/°C
Derate above 25°C		1.8	IIIVV/°C
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

- 1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.
- 2. Alumina = 0.4  $\times$  0.3  $\times$  0.024 in 99.5% alumina.



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SOT-23 CASE 318 STYLE 6

### **MARKING DIAGRAM**



xx = T1, T2, or U1 M = Date Code

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

# BCX17LT1, BCX18LT1, PNP BCX19LT1, NPN

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 0)	BCX17, 19 BCX18	V <sub>(BR)CEO</sub>	45 25	- -	- -	Vdc
Collector–Emitter Breakdown Voltage ( $I_C = 10 \mu Adc, I_C = 0$ )	BCX17, 19 BCX18	V <sub>(BR)CES</sub>	50 30	_ _	_ _	Vdc
Collector Cutoff Current $(V_{CB} = 20 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 20 \text{ Vdc}, I_E = 0, T_A = 150^{\circ}\text{C})$		Ісво	_ _	_ _	100 5.0	nAdc μAdc
Emitter Cutoff Current (V <sub>EB</sub> = 5.0 Vdc, I <sub>C</sub> = 0)		I <sub>EBO</sub>	-	_	10	μAdc
ON CHARACTERISTICS						
DC Current Gain ( $I_C = 100 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$ ) ( $I_C = 300 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$ ) ( $I_C = 500 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$ )		h <sub>FE</sub>	100 70 40	- - -	600 - -	-
Collector–Emitter Saturation Voltage (I <sub>C</sub> = 500 mAdc, I <sub>B</sub> = 50 mAdc)		V <sub>CE(sat)</sub>	-	_	0.62	Vdc
Base–Emitter On Voltage (I <sub>C</sub> = 500 mAdc, V <sub>CE</sub> = 1.0 Vdc)		V <sub>BE(on)</sub>	_	_	1.2	Vdc

## **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
BCX17LT1	T1	SOT-23	3,000 Tape & Reel
BCX17LT1G	T1	SOT-23 (Pb-Free)	3,000 Tape & Reel
BCX17LT3	T1	SOT-23	10,000 Tape & Reel
BCX18LT1	T2	SOT-23	3,000 Tape & Reel
BCX19LT1	U1	SOT-23	3,000 Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# BCX17LT1, BCX18LT1, PNP BCX19LT1, NPN

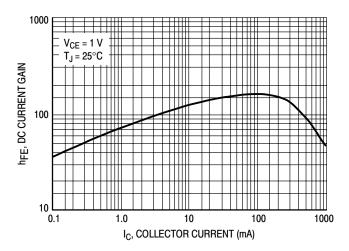


Figure 1. DC Current Gain

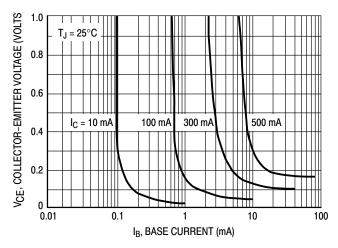


Figure 2. Saturation Region

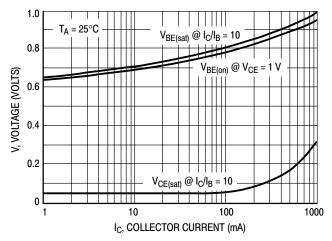
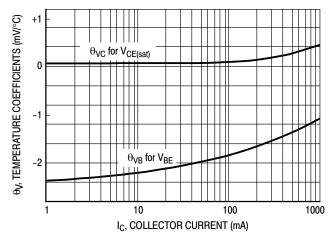


Figure 3. "On" Voltages



**Figure 4. Temperature Coefficients** 

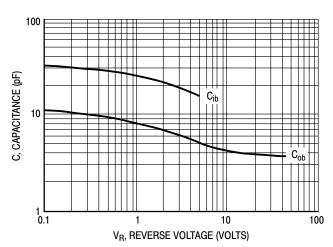
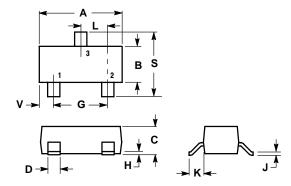


Figure 5. Capacitances

## BCX17LT1, BCX18LT1, PNP BCX19LT1, NPN

#### PACKAGE DIMENSIONS

**SOT-23 (TO-236)** CASE 318-08 ISSUE AK



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
   318-01 THRU -07 AND -09 OBSOLETE, NEW
- 318–01 THRU –07 AND –09 OBSOLETE, NEW STANDARD 318–08.

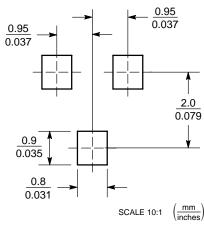
	INCHES		MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.1102	0.1197	2.80	3.04	
В	0.0472	0.0551	1.20	1.40	
С	0.0350	0.0440	0.89	1.11	
D	0.0150	0.0200	0.37	0.50	
G	0.0701	0.0807	1.78	2.04	
Н	0.0005	0.0040	0.013	0.100	
J	0.0034	0.0070	0.085	0.177	
K	0.0140	0.0285	0.35	0.69	
L	0.0350	0.0401	0.89	1.02	
S	0.0830	0.1039	2.10	2.64	
V	0.0177	0.0236	0.45	0.60	

STYLE 6:

PIN 1. BASE

- 2. EMITTER
- 3. COLLECTOR

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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